## **ON Semiconductor**

## Is Now



To learn more about onsemi™, please visit our website at www.onsemi.com

onsemi and ONSEMI. and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. onsemi reserves the right to make changes at any time to any products or information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/ or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use onsemi products for any such unintended or unauthorized application,



#### ON Semiconductor® FDC658AP

## Single P-Channel Logic Level PowerTrench® MOSFET

-30V, -4A, 50mΩ

## **General Description**

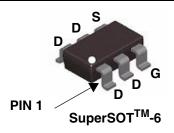
This P-Channel Logic Level MOSFET is produced using ON Semiconductor advanced PowerTrench process. It has been optimized for battery power management applications.

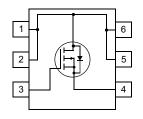
# Applications ■ Battery management

- Load switch
- Battery protection
- DC/DC conversion

#### **Features**

- Max  $r_{DS(on)} = 50 \text{ m}\Omega$  @  $V_{GS} = -10 \text{ V}$ ,  $I_D = -4\text{A}$
- Max  $r_{DS(on)} = 75 \text{ m}\Omega$  @  $V_{GS} = -4.5 \text{ V}$ ,  $I_D = -3.4 \text{A}$
- Low Gate Charge
- High performance trench technology for extremely low r<sub>DS(on)</sub>
- RoHS Compliant





## **Absolute Maximum Ratings** T<sub>A</sub> = 25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
$V_{DS}$	Drain-Source Voltage		-30	V
$V_{GS}$	Gate-Source Voltage		±25	V
	Drain Current - Continuous	(Note 1a)	-4	۸
I <sub>D</sub>	- Pulsed		-20	A
D	Maximum Power dissipation	(Note 1a)	1.6	w
$P_{D}$		(Note 1b)	0.8	VV
$T_{J}$ , $T_{STG}$	Operating and Storage Junction Temperature Range		-55 to +150	°C

#### **Thermal Characteristics**

$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	78	°C/W
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	(Note 1)	30	°C/W

## **Package Marking and Ordering Information**

Device Marking	Device	Reel Size	Tape Width	Quantity
.58A	FDC658AP	7inch	8mm	3000 units

Max

Тур

Min

Units

## **Electrical Characteristics** $T_J = 25^{\circ}\text{C}$ unless otherwise noted

Parameter

Off Characteristics								
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$I_D = -250 \mu A, V_{GS} = 0 V$	-30			V		
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	I <sub>D</sub> = -250μA, Referenced to 25°C		-22		mV/°C		
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{GS} = 0V, V_{DS} = -24V$			-1	μΑ		
I <sub>GSS</sub>	Gate-Body Leakage	$V_{GS} = \pm 25V, V_{DS} = 0V$			±100	nA		

**Test Conditions** 

#### On Characteristics (Note 2)

Symbol

V <sub>GS(TH)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	-1	-1.8	-3	V
$\frac{\Delta V_{GS(TH)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	I <sub>D</sub> = -250μA, Referenced to 25°C		4		mV/°C
r <sub>DS(on)</sub>	Static Drain-Source On-Resistance	$I_D = -4A, V_{GS} = -10V$		44	50	
		$I_D = -3.4A, V_{GS} = -4.5V$		67	75	mΩ
		$I_D = -4A$ , $V_{GS} = -10V$ , $T_J = 125$ °C		60	70	11132
I <sub>D(ON)</sub>	On-State Drain Current	$V_{GS} = -10V, V_{DS} = -5V$	-20			Α
g <sub>FS</sub>	Forward Transconductance	$I_D = -4A, V_{DS} = -5V$		8.4		S

#### **Dynamic Characteristics**

C <sub>iss</sub>	Input Capacitance	V 45V V 0V	470	680	pF
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> = -15V, V <sub>GS</sub> = 0V, f = 1MHz	126	180	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	1 – 111112	61	90	pF

#### **Switching Characteristics** (Note 2)

t <sub>d(on)</sub>	Turn-On Delay Time		7	14	ns
t <sub>r</sub>	Turn-On Rise Time	V <sub>DD</sub> = -15V, I <sub>D</sub> = -1A	12	22	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = -10V$ , $R_{GEN} = 6\Omega$	16	29	ns
t <sub>f</sub>	Turn-Off Fall Time		6	12	ns
$Q_g$	Total Gate Charge	V 45V L 4A	6	8.1	nC
$Q_{gs}$	Gate-Source Charge	$V_{DS} = -15V, I_{D} = -4A, V_{GS} = -5V$	2.1		nC
Q <sub>gd</sub>	Gate-Drain Charge	VGS - 3V	2		nC

#### **Drain-Source Diode Characteristics and Maximum Ratings**

$I_S$	Maximum Continuous Drain-Source Diode Forward Current			-1.3	Α
$V_{SD}$	Drain-Source Diode Forward Voltage	$V_{GS} = 0V$ , $I_S = -1.3$ A (Note 2)	-0.77	-1.2	V

#### Notes:

<sup>1:</sup> R<sub>BJA</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R<sub>BJC</sub> is guaranteed by design while R<sub>BCA</sub> is determined by the user's board design.



a) 78°C/W when mounted on a 1 in² pad of 2 oz copper



b) 156°C/W whe mounted on a minimum pad of 2 oz copper

Scale 1: 1 on letter size paper

2: Pulse Test: Pulse Width < 300  $\mu$ s, Duty Cycle < 2.0%

## **Typical Characteristics**

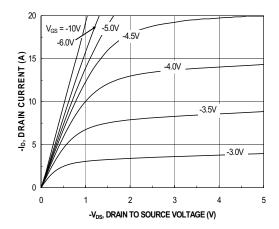


Figure 1. On-Region Characteristics

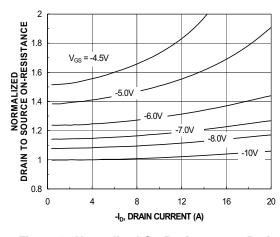


Figure 2. Normalized On-Resistance vs Drain Current and Gate Voltage

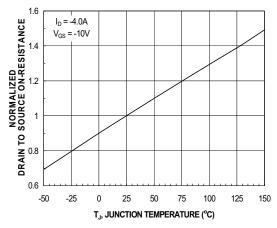


Figure 3. Normalized On-Resistance vs Junction Temperature

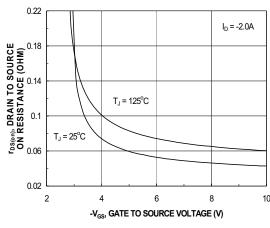


Figure 4. On-Resistance vs Gate to Source Voltage

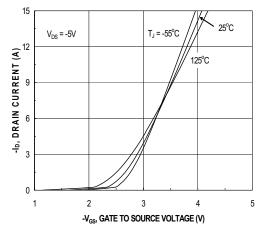


Figure 5. Transfer Characteristics

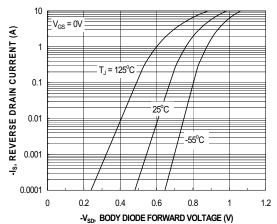


Figure 6. Source to Drain Diode Forward Voltage vs Source Current

### **Typical Characteristics**

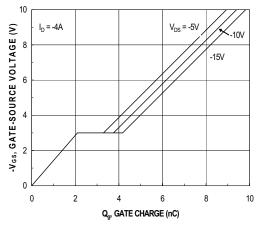
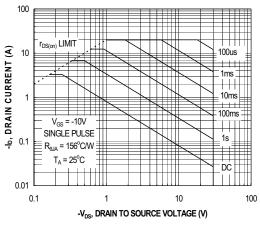


Figure 7. Gate Charge Characteristics

Figure 8. Capacitance vs Drain to Source Voltage



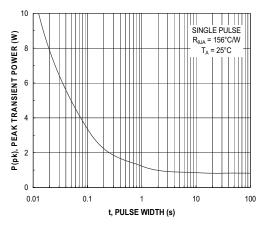


Figure 9. Forward Bias Safe Operating Area

Figure 10. Single Pulse Maximum Power Dissipation

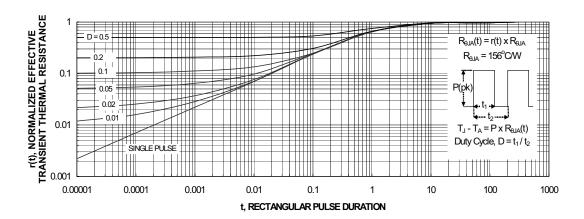


Figure 11. Transient Thermal Response Curve

Thermal characterization performed using the conditions described in Note 1b. Transient thermal response will change depending on the circuit board design.

ON Semiconductor and in are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <a href="www.onsemi.com/site/pdf/Patent-Marking.pdf">www.onsemi.com/site/pdf/Patent-Marking.pdf</a>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hol

#### **PUBLICATION ORDERING INFORMATION**

#### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800-282-9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Phone: 421 33 790 2910

Japan Customer Focus Center
Phone: 81–3–5817–1050

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

## **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for MOSFET category:

Click to view products by ON Semiconductor manufacturer:

Other Similar products are found below:

614233C 648584F IRFD120 JANTX2N5237 FCA20N60\_F109 FDZ595PZ 2SK2545(Q,T) 405094E 423220D TPCC8103,L1Q(CM MIC4420CM-TR VN1206L SBVS138LT1G 614234A 715780A NTNS3166NZT5G SSM6J414TU,LF(T 751625C BUK954R8-60E NTE6400 SQJ402EP-T1-GE3 2SK2614(TE16L1,Q) 2N7002KW-FAI DMN1017UCP3-7 EFC2J004NUZTDG ECH8691-TL-W FCAB21350L1 P85W28HP2F-7071 DMN1053UCP4-7 NTE221 NTE222 NTE2384 NTE2903 NTE2941 NTE2945 NTE2946 NTE2960 NTE2967 NTE2969 NTE2976 NTE455 NTE6400A NTE2910 NTE2916 NTE2956 NTE2956 NTE2911 DMN2080UCB4-7 TK10A80W,S4X(S SSM6P69NU,LF DMP22D4UFO-7B